POLYURETHANE ADHESIVE TAD-N-PU-2C HALA

thermally conductive / 2 part / dispensable / Form-in-Place

TAD-N-PU-2C is a thermally conductive and thixotropic PU adhesive made from highly filled A and B components. The adhesive begins to cure immediately after the two components are thoroughly mixed. TAD-N-PU-2C is characterized by high wetting properties and excellent bond strength on most surfaces. The adhesive system cures completely at room temperature, and curing is accelerated at higher temperatures.

Due to its thixotropic properties, TAD-N-PU-2C can also be used as a dispensable two-component system: Form-in-Place Gap Filler, which creates a precisely placeable gap filler system that cures directly in place, allowing gaps with very tight tolerances to be filled, especially in non-planar structures.

AVAILABILITY

☐ 2 x 1 kg cans

☐ 18 l in pails



APPLICATION EXAMPLES

- □ LED systems Processor cooling
- Memory chip assembly
- CPU boards
- EHV battery systems

PROPERTIES

PROPERTY

- ☐ Thermal conductivity: 2 W/mK
- Very high bonding properties
- Extraordinary chemical resistance and longterm stability
- Zero stress on components
- Heat accelerated curing

UNIT A-Part **B-Part**

☐ 400 ml (2 x 200 ml) twin cartridges

	Polycaprolactam with fillers	Diphenylmethan - 4,4'-diisocyanate with fillers
•	Black	White
Pas	320 / 280	272 / 165
Pas	520	
g/cm³	2.3	2.6
g/cm³		2.45
Shore D	70	
Volume	1:1	
psi	1,380	
psi	2,030	
%		30
Months	Cartridges: 6 / Pails: 4	
°C		15-25
		< 24 h
UL 94		V0
2015 / 863 / EU		Yes
W/mK		2.0
°C		- 40 to + 85
kV/mm		13.5
Ohm - cm		4.55 x 10 ¹²
	Pas g/cm³ g/cm³ Shore D Volume psi psi % Months °C UL 94 2015 / 863 / EU W/mK °C	Black Pas 320 / 280 Pas

Measurement technique according to: 'ASTM D 5470. All data without warranty and subject to change. Please contact us for further data and information.